DOCKET NO.: 268844US2PCT



### IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

IN RE APPLICATION OF: Hiroshi SHIHO et al.

SERIAL NUMBER: 10/529,742

FILED: March 29, 2005

FOR: POLISHING PAD FOR SEMICONDUCTOR WAFER, POLISHING

MULTILAYERED BODY FOR SEMICONDUCTOR WAFER HAVING SAME, AND

METHOD FOR POLISHING SEMICONDUCTOR WAFER

### RESPONSE TO NOTICE OF MISSING REQUIREMENTS UNDER 35 U.S.C. 371

COMMISSIONER FOR PATENTS Box PCT Alexandria, VA 22313

SIR:

Responsive to the notification dated November 30, 2005, and in accordance with the provisions of 35 U.S.C. 371, Applicants submit herewith a Rule 63 Declaration, a Supplemental Application Data Sheet, a General Power of Attorney, and a Statement Under 37 CFR 3.73 (b).

In light of the foregoing, this application is deemed to be in proper condition for examination and such favorable action is earnestly solicited.

Our payment in the amount of \$-0.00- is attached hereto. If any variance exists between the amount enclosed and the required Government fee, please charge or credit the difference to our Deposit Account No. 15-0030. A duplicate copy of this sheet is enclosed.

If these papers are not considered timely filed by the Patent and Trademark Office, then a petition is hereby made under 37 C.F.R. §1.136 and any additional fees required under 37 C.F.R. §1.136 for any necessary extension of time may be charged to Deposit Account No. 15-0030. A duplicate copy of this sheet is enclosed.

Respectfully submitted,

OBLON, SPIVAK, McCLELLAND,

MAIER & NEUSTADT, P.C.

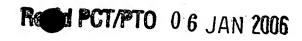
Customer Number 22850 -

Marvin J. Spivak Attorney of Record Registration No. 24,913

Surinder Sachar

Registration No. 34,423

(703) 413-3000



STATEMENT UNDER 37 CFR 3.73(b)				
Applicant/Patent Owner: <u>Hiroshi SHIHO, et al.</u>				
Application No./Patent No.: 10/529,742 Filed/Issue D POLISHING PAD FOR SEMICONDUCTOR WAFER, POLISHING MULTILAYERED BODY FOR SEMICONDUCTOR WAFER HAVING SAME, AN Entitled: METHOD FOR POLISHING SEMICONDUCTOR WAFER	eate: March 29, 2005			
JSR Corporation , a Corporation				
(Name of Assignee) (Type of Assignee, e.g., corporation, p	eartnership, government agency, etc.)			
States that it is:				
1. the assignee of the entire right, title, and interest; or	•			
2.   an assignee of less than the entire right, title and interest.				
The extent (by, percentage) of its ownership interest is%				
in the patent application/patent identified above by virtue of an assignment from the inventor application/patent identified above. A copy of the assignment is attached. The assignment being recorded concurrently herewith.				
The undersigned (whose title is supplied below) is authorized to act on behalf of the assigned Surinder Sachar Registration No. 34,423	ee.			
fundi Jochen Hegistration 140. 54,425	Jan 6 2006			
Signature	Date			
Marvin J. Spivak	703-413-3000			
Printed or Typed Name	Telephone Number			
24,913				
Registration Number				

## **Assignment of Application**

INSERT NAMES AND RESIDENCE		·-·		AWA and Nobuo KAWAHASI	
ADDRESS OF THE INVENTORS:		apan		·	
					·
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				<del></del>	
			7		
					, respectively
INSERT TITLE OF INVENTION:	have invented certain	new and useful improven	nents in: POLISHING	PAD FOR SEMICONDUCTO	R WAFER AND
				AFER EQUIPPED WITH TH	A CONTRACTOR OF THE CONTRACTOR
	WELL AS METHOL	FOR POLISHING OF S	EMICONDUCTOR W	AFER	
	(Application No.	10/529,742	, filed	March 29, 2005	), and
	WHEREAS, JS	R Corporation			
INSERT NAME	· · · · · · · · · · · · · · · · · · ·	•			

(hereinaster referred to as "ASSIGNEE") having a place of business at: 6-10, Tsukiji 5-chome, Chuo-ku, Tokyo, Japan is desirous of acquiring the entire right, title and interest in and to said invention and in and to any Letters Patent that may be granted therefore in the United States and its territorial possessions and in any and all foreign countries;

NOW, THEREFORE, in consideration of the sum of FIVE DOLLARS (\$5.00), the receipt whereof is hereby acknowledged, and for other good and valuable consideration, I (WE), by these presents do sell, assign and transfer unto said ASSIGNEE, the full and exclusive right to the said invention in the United States and its territorial possessions and in all foreign countries and the entire right, title and interest in and to any and all Letters Patent which may be granted therefor in the United States and its territorial possessions and in any and all foreign countries and in and to any and all divisions, reissues, continuations, substitutions and renewals thereof.

I (WE) hereby authorize and request the Patent Office Officials in the United States and its territorial possessions and any and all foreign countries to issue any and all of said Letters Patent, when granted, to said ASSIGNEE as the assignee of my (our) entire right, title and interest in and to the same, for the sole use and behoof of said ASSIGNEE, its (his) successors and assigns, to the full end of the term for which said Letters Patent may be granted, as fully and entirely as the same would have been held by me (us) had this Assignment and sale not been made.



Further, I (WE) agree that I (WE) will communicate to said ASSIGNEE or its (his) representatives any facts known to me (us) respecting said invention, and testify in any legal proceeding, sign all lawful papers, execute all divisional, continuation, substitute, renewal and reissue applications, execute all necessary assignment papers to cause any and all of said Letter Patent to be issued to said ASSIGNEE, make all rightful oaths, and, generally do everything possible to aid said ASSIGNEE, its (his) successors and assigns, to obtain and enforce proper protection for said invention in the United States and its territorial possessions and in any and all foreign countries.

The undersigned hereby grant(s) the firm of Oblon, Spivak, McClelland, Maier & Neustadt, P.C. of 1940 Duke Street, Alexandria, Virginia 22314 the power to insert on this assignment any further identification, including the application number and filing date, which may be necessary or desirable in order to comply with the rules of the United States Patent and Trademark Office for recordation of this document.

Date:	April 8, 2005	·.	Miroshi Shih
_			(Signature of Inventor) Hiroshi SHIHO
Date:	2005-4.8		Jukio Hosaka
			(Signature of Inventor) Yukio HOSAKA
Date:	April 8. 2005		How Hasegawa
-			(Signature of Inventor) Kou HASEGAWA
Date:	April 8, 2005		Tules long
_			(Signature of Inventor) Nobuo KAWAHASHI
Date:			
-		•	(Signature of Inventor)
			J
Date:			
	,		(Signature of Inventor)

OBLON, SPIVAK, McCLELLAND, MAIER & NEUSTADT, P.C.
ATTORNEYS AT LAW
1940 DUKE STREET
ALEXANDRIA, VIRGINIA 22314



## UNITED STATES PATENT AND TRADEMARK OFFICE

# Rec'd PCT/PTO 06 JAN 2006

UNITED STATES DEPARTMENT OF COMMERCE United States Patent and Trademark Office Address: COMMISSIONER FOR PATENTS O Alexandria, Virginia 22313-1450 www.uspto.gov

U.S.	APPLICA?	CION	NUMBER	NO.

FIRST NAMED APPLICANT

ATTY. DOCKET NO.

10/529,742

Hiroshi Shiho

268844US2PCT

INTERNATIONAL APPLICATION NO.

PCT/JP04/05963

I.A. FILING DATE

PRIORITY DATE

04/23/2004

1940 DUKE STREET ALEXANDRIA, VA 22314

22850

ET

**CONFIRMATION NO. 8533 371 FORMALITIES LETTER** 

\*OC00000017495600\*

Date Mailed: 11/30/2005

## NOTIFICATION OF MISSING REQUIREMENTS UNDER 35 U.S.C. 371 IN THE UNITED STATES DESIGNATED/ELECTED OFFICE (DO/EO/US)

The following items have been submitted by the applicant or the IB to the United States Patent and Trademark Office as a Designated / Elected Office (37 CFR 1.495).

Copy of the International Application filed on 03/29/2005

OBLON, SPIVAK, MCCLELLAND, MAIER & NEUSTADT, P.C.

- Copy of the International Search Report filed on 03/29/2005
- Preliminary Amendments filed on 05/03/2005
- Information Disclosure Statements filed on 03/29/2005
- Request for Immediate Examination filed on 03/29/2005
- U.S. Basic National Fees filed on 03/29/2005

OBLON, SPIVAK, McCLELLAND MAIER & NEUSTADT, P.C.

DOCKETING DE

Initials/Date Docketed: [Jufa]

Type of Resp(s): DOLLS Due Date(s):

:-

The following items MUST be furnished within the period set forth below in order to complete the requirements for acceptance under 35 U.S.C. 371:

Oath or declaration of the inventors, in compliance with 37 CFR 1.497(a) and (b), identifying the application by the International application number and international filing date.

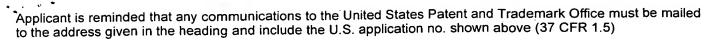
#### SUMMARY OF FEES DUE:

Total additional fees required for this application is \$-360 for a Large Entity:

(A previous payment of \$360 will be applied to the additional fees indicated above.)

ALL OF THE ITEMS SET FORTH ABOVE MUST BE SUBMITTED WITHIN TWO (2) MONTHS FROM THE DATE OF THIS NOTICE OR BY 32 MONTHS FROM THE PRIORITY DATE FOR THE APPLICATION, WHICHEVER IS LATER. FAILURE TO PROPERLY RESPOND WILL RESULT IN ABANDONMENT.

The time period set above may be extended by filing a petition and fee for extension of time under the provisions of 37 CFR 1.136(a).



A copy of this notice **MUST** be returned with the response.

### FREDERICK SMITH

Telephone: (703) 308-9140 EXT 210

### PART 1 - ATTORNEY/APPLICANT COPY

U.S. APPLICATION NUMBER NO.	INTERNATIONAL APPLICATION NO.	ATTY, DOCKET NO.
10/529,742	PCT/JP04/05963	268844US2PCT

FORM PCT/DO/EO/905 (371 Formalities Notice)